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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded - Microcontrollers</u>"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	10MHz
Connectivity	-
Peripherals	POR, WDT
Number of I/O	20
Program Memory Size	3KB (2K x 12)
Program Memory Type	ОТР
EEPROM Size	-
RAM Size	72 x 8
Voltage - Supply (Vcc/Vdd)	4.5V ~ 5.5V
Data Converters	-
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Through Hole
Package / Case	28-DIP (0.300", 7.62mm)
Supplier Device Package	28-SPDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16c57-10i-sp



8-Bit EPROM/ROM-Based CMOS Microcontrollers

1.0 GENERAL DESCRIPTION

The PIC16C5X from Microchip Technology is a family of low cost, high performance, 8-bit fully static, EPROM/ROM-based CMOS microcontrollers. It employs a RISC architecture with only 33 single word/single cycle instructions. All instructions are single cycle except for program branches which take two cycles. The PIC16C5X delivers performance in an order of magnitude higher than its competitors in the same price category. The 12-bit wide instructions are highly symmetrical resulting in 2:1 code compression over other 8-bit microcontrollers in its class. The easy to use and easy to remember instruction set reduces development time significantly.

The PIC16C5X products are equipped with special features that reduce system cost and power requirements. The Power-on Reset (POR) and Device Reset Timer (DRT) eliminate the need for external RESET circuitry. There are four oscillator configurations to choose from, including the power saving LP (Low Power) oscillator and cost saving RC oscillator. Power saving SLEEP mode, Watchdog Timer and Code Protection features improve system cost, power and reliability.

The UV erasable CERDIP packaged versions are ideal for code development, while the cost effective One Time Programmable (OTP) versions are suitable for production in any volume. The customer can take full advantage of Microchip's price leadership in OTP microcontrollers, while benefiting from the OTP's flexibility.

The PIC16C5X products are supported by a full featured macro assembler, a software simulator, an in-circuit emulator, a low cost development programmer and a full featured programmer. All the tools are supported on IBM® PC and compatible machines.

1.1 Applications

The PIC16C5X series fits perfectly in applications ranging from high speed automotive and appliance motor control to low power remote transmitters/receivers, pointing devices and telecom processors. The EPROM technology makes customizing application programs (transmitter codes, motor speeds, receiver frequencies, etc.) extremely fast and convenient. The small footprint packages, for through hole or surface mounting, make this microcontroller series perfect for applications with space limitations. Low cost, low power, high performance ease of use and I/O flexibility make the PIC16C5X series very versatile even in areas where no microcontroller use has been considered before (e.g., timer functions, replacement of "glue" logic in larger systems, co-processor applications).

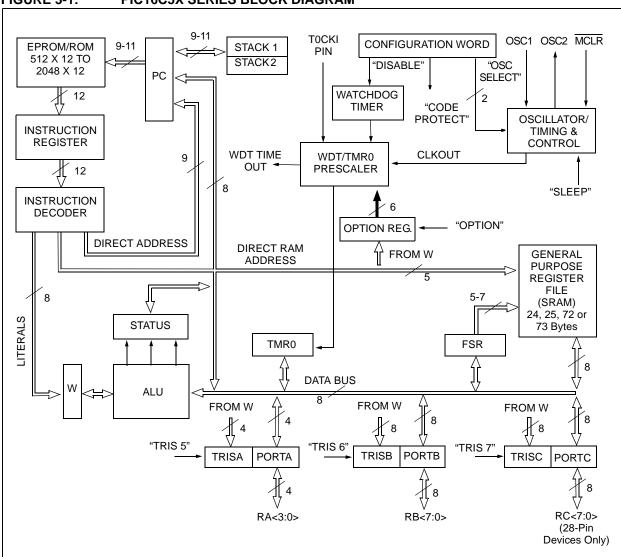


FIGURE 3-1: PIC16C5X SERIES BLOCK DIAGRAM

TABLE 3-2: PINOUT DESCRIPTION - PIC16C55, PIC16C57, PIC16CR57

Din Name	Pin Number		Pin	Buffer	Description	
Pin Name	DIP	SOIC	SSOP	Туре	Type	Description
RA0	6	6	5	I/O	TTL	Bi-directional I/O port
RA1	7	7	6	I/O	TTL	·
RA2	8	8	7	I/O	TTL	
RA3	9	9	8	I/O	TTL	
RB0	10	10	9	I/O	TTL	Bi-directional I/O port
RB1	11	11	10	I/O	TTL	·
RB2	12	12	11	I/O	TTL	
RB3	13	13	12	I/O	TTL	
RB4	14	14	13	I/O	TTL	
RB5	15	15	15	I/O	TTL	
RB6	16	16	16	I/O	TTL	
RB7	17	17	17	I/O	TTL	
RC0	18	18	18	I/O	TTL	Bi-directional I/O port
RC1	19	19	19	I/O	TTL	
RC2	20	20	20	I/O	TTL	
RC3	21	21	21	I/O	TTL	
RC4	22	22	22	I/O	TTL	
RC5	23	23	23	I/O	TTL	
RC6	24	24	24	I/O	TTL	
RC7	25	25	25	I/O	TTL	
T0CKI	1	1	2	I	ST	Clock input to Timer0. Must be tied to Vss or VDD, if not in use, to reduce current consumption.
MCLR	28	28	28	I	ST	Master clear (RESET) input. This pin is an active low RESET to the device.
OSC1/CLKIN	27	27	27	I	ST	Oscillator crystal input/external clock source input.
OSC2/CLKOUT	26	26	26	0	_	Oscillator crystal output. Connects to crystal or resonator in crystal Oscillator mode. In RC mode, OSC2 pin outputs CLKOUT which has 1/4 the frequency of OSC1, and denotes the instruction cycle rate.
VDD	2	2	3,4	Р	_	Positive supply for logic and I/O pins.
Vss	4	4	1,14	Р		Ground reference for logic and I/O pins.
N/C	3,5	3,5		_		Unused, do not connect.

Legend: I = input, O = output, I/O = input/output, P = power, — = Not Used, TTL = TTL input, ST = Schmitt Trigger input

NOTES:

6.5.1 PAGING CONSIDERATIONS – PIC16C56/CR56, PIC16C57/CR57 AND PIC16C58/CR58

If the Program Counter is pointing to the last address of a selected memory page, when it increments it will cause the program to continue in the next higher page. However, the page preselect bits in the STATUS Register will not be updated. Therefore, the next GOTO, CALL or modify PCL instruction will send the program to the page specified by the page preselect bits (PAO or PA<1:0>).

For example, a NOP at location 1FFh (page 0) increments the PC to 200h (page 1). A GOTO xxx at 200h will return the program to address xxh on page 0 (assuming that PA<1:0> are clear).

To prevent this, the page preselect bits must be updated under program control.

6.5.2 EFFECTS OF RESET

The Program Counter is set upon a RESET, which means that the PC addresses the last location in the last page (i.e., the RESET vector).

The STATUS Register page preselect bits are cleared upon a RESET, which means that page 0 is preselected.

Therefore, upon a RESET, a GOTO instruction at the RESET vector location will automatically cause the program to jump to page 0.

6.6 Stack

PIC16C5X devices have a 10-bit or 11-bit wide, two-level hardware push/pop stack.

A CALL instruction will push the current value of stack 1 into stack 2 and then push the current program counter value, incremented by one, into stack level 1. If more than two sequential CALL's are executed, only the most recent two return addresses are stored.

A RETLW instruction will pop the contents of stack level 1 into the program counter and then copy stack level 2 contents into level 1. If more than two sequential RETLW's are executed, the stack will be filled with the address previously stored in level 2. Note that the W Register will be loaded with the literal value specified in the instruction. This is particularly useful for the implementation of data look-up tables within the program memory.

For the RETLW instruction, the PC is loaded with the Top of Stack (TOS) contents. All of the devices covered in this data sheet have a two-level stack. The stack has the same bit width as the device PC, therefore, paging is not an issue when returning from a subroutine.

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NOTES:

REGISTER 9-2: CONFIGURATION WORD FOR PIC16C54/C55/C56/C57

bit 11 bit 0

bit 11-4: Unimplemented: Read as '0'

bit 3: **CP:** Code protection bit.

1 = Code protection off0 = Code protection on

bit 2: WDTE: Watchdog timer enable bit

1 = WDT enabled 0 = WDT disabled

bit 1-0: FOSC1:FOSC0: Oscillator selection bits⁽²⁾

00 = LP oscillator 01 = XT oscillator 10 = HS oscillator 11 = RC oscillator

Note 1: Refer to the PIC16C5X Programming Specifications (Literature Number DS30190) to determine how to access the configuration word.

2: PIC16LV54A supports XT, RC and LP oscillator only.

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR 1 = bit is set 0 = bit is cleared x = bit is unknown

NOTES:

COMF	Complement f							
Syntax:	[label]	COMF	f,d					
Operands:	$0 \le f \le 31$ $d \in [0,1]$							
Operation:	$(\overline{f}) \rightarrow (de$	est)						
Status Affected:	Z							
Encoding:	0010	01df	ffff					
Description:	The contents of register 'f' are complemented. If 'd' is 0 the result is stored in the W register. If 'd' is 1 the result is stored back in register 'f'.							
Words:	1							
Cycles:	1							
Example:	COMF	REG1,0						
Before Instru REG1 After Instruct REG1 W	= 02 ion = 02	x13 x13 xEC						

DECF	Decrement f							
Syntax:	[label]	DECF f,	d					
Operands:	$0 \le f \le 31$ $d \in [0,1]$							
Operation:	$(f) - 1 \rightarrow$	(dest)						
Status Affected:	Z							
Encoding:	0000	11df	ffff					
Description:	Decrement register 'f'. If 'd' is 0 the result is stored in the W register. If 'd' is 1 the result is stored back in register 'f'.							
Words:	1							
Cycles:	1							
Example:	DECF	CNT,	1					
Before Instru CNT Z After Instruct CNT Z	= 0: = 0 tion	x01 x00						

DECFSZ	Decrement f, Skip if 0						
Syntax:	[label] DECFSZ f,d						
Operands:	$0 \le f \le 31$						
	d ∈ [0,1]						
Operation:	$(f) - 1 \rightarrow d$; skip if result = 0						
Status Affected:	None						
Encoding:	0010 lldf ffff						
Description:	The contents of register 'f' are decremented. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is placed back in register 'f'. If the result is 0, the next instruction, which is already fetched, is discarded and a NOP is executed instead making it a two-cycle instruction.						
Words:	1						
Cycles:	1(2)						
Example:	HERE DECFSZ CNT, 1						
	GOTO LOOP CONTINUE •						
Before Instru	uction						
PC	= address (HERE)						
After Instruct							
CNT	= CNT - 1;						
if CNT PC	= 0,						
if CNT	= address (CONTINUE); ≠ 0.						
PC	= address (HERE+1)						

12.5 DC Characteristics: PIC16C54/55/56/57-RCE, XTE, 10E, HSE, LPE (Extended)

DC CH	DC CHARACTERISTICS			Standard Operating Conditions (unless otherwise specified) Operating Temperature $-40^{\circ}\text{C} \le \text{Ta} \le +125^{\circ}\text{C}$ for extended					
Param No.	Symbol	Characteristic	Min	Typ†	Max	Units	Conditions		
D030	VIL	Input Low Voltage I/O ports MCLR (Schmitt Trigger) TOCKI (Schmitt Trigger) OSC1 (Schmitt Trigger) OSC1 (Schmitt Trigger)	Vss Vss Vss Vss Vss	11111	0.15 VDD 0.15 VDD 0.15 VDD 0.15 VDD 0.3 VDD	V V V V	Pin at hi-impedance PIC16C5X-RC only ⁽³⁾ PIC16C5X-XT, 10, HS, LP		
D040	VHYS	Input High Voltage I/O ports I/O ports I/O ports MCLR (Schmitt Trigger) TOCKI (Schmitt Trigger) OSC1 (Schmitt Trigger) OSC1 (Schmitt Trigger) Hysteresis of Schmitt	0.45 VDD 2.0 0.36 VDD 0.85 VDD 0.85 VDD 0.85 VDD 0.7 VDD		VDD VDD VDD VDD VDD VDD VDD VDD	V V V V V	For all $VDD^{(4)}$ $4.0V < VDD \le 5.5V^{(4)}$ VDD > 5.5 V PIC16C5X-RC only ⁽³⁾ PIC16C5X-XT, 10, HS, LP		
D060	lι∟	Trigger inputs Input Leakage Current (1,2) I/O ports MCLR MCLR TOCKI OSC1	-1 -5 -3 -3	0.5 0.5 0.5 0.5	+1 +5 +3 +3	μΑ μΑ μΑ μΑ μΑ	For VDD \leq 5.5 V: VSS \leq VPIN \leq VDD, pin at hi-impedance VPIN = VSS + 0.25V VPIN = VDD VSS \leq VPIN \leq VDD VSS \leq VPIN \leq VDD, PIC16C5X-XT, 10, HS, LP		
D080	Vol	Output Low Voltage I/O ports OSC2/CLKOUT		_	0.6 0.6	V V	IOL = 8.7 mA, VDD = 4.5V IOL = 1.6 mA, VDD = 4.5V, PIC16C5X-RC		
D090	Voн	Output High Voltage ⁽²⁾ I/O ports OSC2/CLKOUT	VDD - 0.7 VDD - 0.7	_		V V	IOH = -5.4 mA, VDD = 4.5V IOH = -1.0 mA, VDD = 4.5V, PIC16C5X-RC		

^{*} These parameters are characterized but not tested.

[†] Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.

Note 1: The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltage.

^{2:} Negative current is defined as coming out of the pin.

^{3:} For PIC16C5X-RC devices, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C5X be driven with external clock in RC mode.

^{4:} The user may use the better of the two specifications.

FIGURE 12-5: TIMER0 CLOCK TIMINGS - PIC16C54/55/56/57

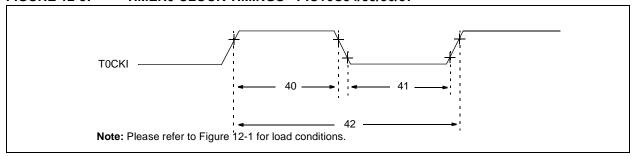


TABLE 12-4: TIMERO CLOCK REQUIREMENTS - PIC16C54/55/56/57

AC Characteristics Standard Operating Conditions (unless otherwise specified) Operating Temperature $0^{\circ}C \le TA \le +70^{\circ}C$ for commercial $-40^{\circ}C \le TA \le +85^{\circ}C$ for industrial $-40^{\circ}C \le TA \le +125^{\circ}C$ for extended							i)
Param No.	Symbol	Characteristic	Min	Тур†	Max	Units	Conditions
40	Tt0H	TOCKI High Pulse Width - No Prescaler - With Prescaler	0.5 Tcy + 20* 10*			ns ns	
41	Tt0L	Tocki Low Pulse Width - No Prescaler - With Prescaler	0.5 TcY + 20* 10*	_	_	ns ns	
42	Tt0P	T0CKI Period	20 or <u>Tcy + 40</u> * N	_	_	ns	Whichever is greater. N = Prescale Value (1, 2, 4,, 256)

These parameters are characterized but not tested.

[†] Data in the Typical ("Typ") column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

MAXIMUM IDD VS. FREQUENCY (EXTERNAL CLOCK, -40°C TO +85°C) FIGURE 14-13: Typical: statistical mean @ 25°C Maximum: mean + 3s (-40°C to 125°C) Minimum: mean - 3s (-40°C to 125°C) 10 1.0 IDD (mA) 7.0 6.5 0.1 4.0 3.5 = 3.0 0.01 10K 100K 1M 10M 100M External Clock Frequency (Hz)



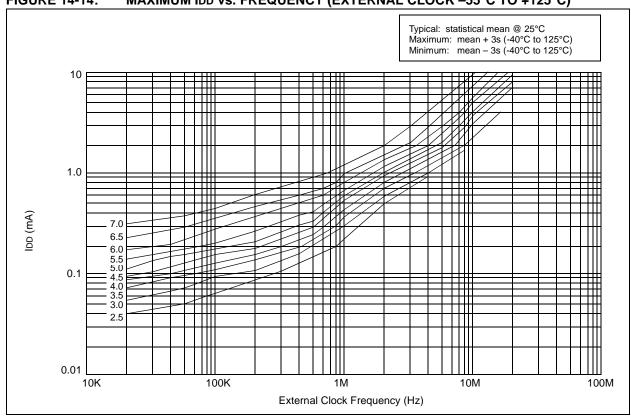


TABLE 14-2: INPUT CAPACITANCE FOR PIC16C54/56

Pin	Typical Capacitance (pF)				
FIII	18L PDIP	18L SOIC			
RA port	5.0	4.3			
RB port	5.0	4.3			
MCLR	17.0	17.0			
OSC1	4.0	3.5			
OSC2/CLKOUT	4.3	3.5			
T0CKI	3.2	2.8			

All capacitance values are typical at 25°C. A part-to-part variation of $\pm 25\%$ (three standard deviations) should be taken into account.

TABLE 14-3: INPUT CAPACITANCE FOR PIC16C55/57

	Typical Capacitance (pF)				
Pin	28L PDIP (600 mil)	28L SOIC			
RA port	5.2	4.8			
RB port	5.6	4.7			
RC port	5.0	4.1			
MCLR	17.0	17.0			
OSC1	6.6	3.5			
OSC2/CLKOUT	4.6	3.5			
TOCKI	4.5	3.5			

All capacitance values are typical at 25°C. A part-to-part variation of $\pm 25\%$ (three standard deviations) should be taken into account.

FIGURE 16-16: WDT TIMER TIME-OUT PERIOD vs. VDD⁽¹⁾

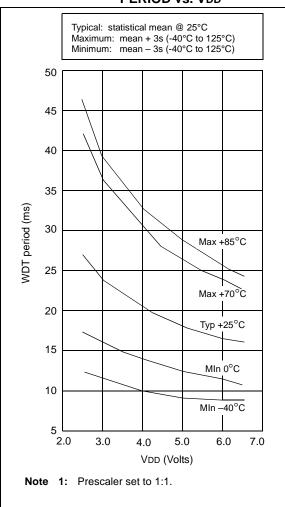


FIGURE 16-17: TRANSCONDUCTANCE (gm) OF HS OSCILLATOR vs. VDD

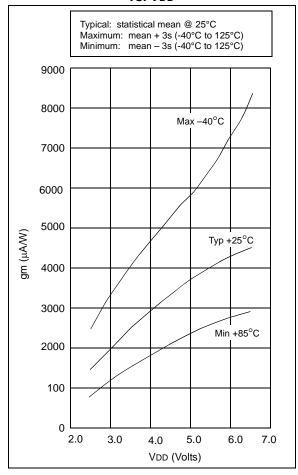


FIGURE 17-9: TIMERO CLOCK TIMINGS - PIC16C5X, PIC16CR5X

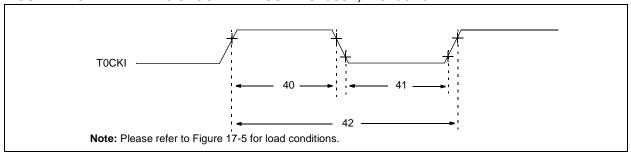


TABLE 17-4: TIMERO CLOCK REQUIREMENTS - PIC16C5X, PIC16CR5X

Standard Operating Conditions (unless otherwise specified)									
AC Characteristics Operating Temperature $0^{\circ}\text{C} \le \text{TA} \le +70^{\circ}\text{C}$ for commercial $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for industrial $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C}$ for extended							trial		
Param No.	Symbol	Characteristic	Min	Тур†	Max	Units	Conditions		
40	Tt0H	T0CKI High Pulse Width - No Prescaler	0.5 Tcy + 20*	_	_	ns			
		- With Prescaler	10*	_	_	ns			
41	TtOL	T0CKI Low Pulse Width - No Prescaler	0.5 Tcy + 20*	_	_	ns			
		- With Prescaler	10*	_	_	ns			
42	Tt0P	T0CKI Period	20 or <u>Tcy + 40</u> * N	_	_	ns	Whichever is greater. N = Prescale Value (1, 2, 4,, 256)		

^{*} These parameters are characterized but not tested.

[†] Data in the Typical ("Typ") column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

19.0 ELECTRICAL CHARACTERISTICS - PIC16LC54C 40MHz

Absolute Maximum Ratings(†)

Ambient temperature under bias	55°C to +125°C
Storage temperature	–65°C to +150°C
Voltage on VDD with respect to Vss	
Voltage on MCLR with respect to Vss	0 to +14V
Voltage on all other pins with respect to Vss	0.6V to (VDD + 0.6V)
Total power dissipation ⁽¹⁾	800 mW
Max. current out of Vss pin	
Max. current into VDD pin	100 mA
Max. current into an input pin (T0CKI only)	±500 μA
Input clamp current, IiK (VI < 0 or VI > VDD)	±20 mA
Output clamp current, loκ (Vo < 0 or Vo > VDD)	±20 mA
Max. output current sunk by any I/O pin	25 mA
Max. output current sourced by any I/O pin	20 mA
Max. output current sourced by a single I/O (Port A, B or C)	50 mA
Max. output current sunk by a single I/O (Port A, B or C)	50 mA
Note 1: Power dissipation is calculated as follows: Pdis = VDD x {IDD - Σ IOH} + Σ {(VDD-\	VOH) $x IOH$ + $\sum (VOL x IOL)$

† NOTICE: Stresses above those listed under "Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

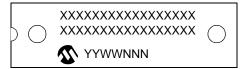
21.0 PACKAGING INFORMATION

21.1 Package Marketing Information

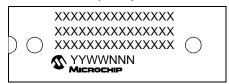
18-Lead PDIP



28-Lead Skinny PDIP (.300")



28-Lead PDIP (.600")



18-Lead SOIC



28-Lead SOIC



20-Lead SSOP



28-Lead SSOP



Example



Example



Example



Example



Example



Example

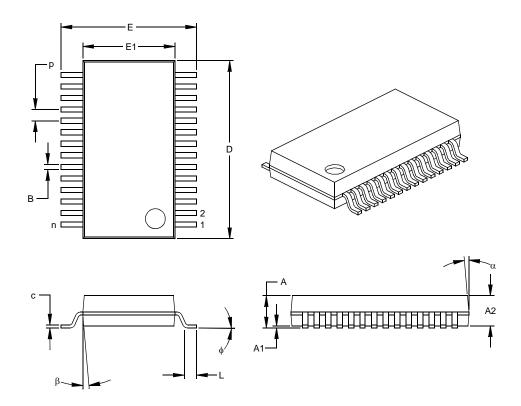


Example



28-Lead Plastic Shrink Small Outline (SS) - 209 mil, 5.30 mm (SSOP)

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



		INCHES			MILLIMETERS*		
Dimension	Limits	MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		28			28	
Pitch	р		.026			0.65	
Overall Height	Α	.068	.073	.078	1.73	1.85	1.98
Molded Package Thickness	A2	.064	.068	.072	1.63	1.73	1.83
Standoff §	A1	.002	.006	.010	0.05	0.15	0.25
Overall Width	Е	.299	.309	.319	7.59	7.85	8.10
Molded Package Width	E1	.201	.207	.212	5.11	5.25	5.38
Overall Length	D	.396	.402	.407	10.06	10.20	10.34
Foot Length	L	.022	.030	.037	0.56	0.75	0.94
Lead Thickness	С	.004	.007	.010	0.10	0.18	0.25
Foot Angle	ф	0	4	8	0.00	101.60	203.20
Lead Width	В	.010	.013	.015	0.25	0.32	0.38
Mold Draft Angle Top	α	0	5	10	0	5	10
Mold Draft Angle Bottom	β	0	5	10	0	5	10

Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side.

JEDEC Equivalent: MS-150 Drawing No. C04-073

^{*} Controlling Parameter § Significant Characteristic

INDEX	Extended	82, 84
	Industrial	80, 83
A	PIC16LV54A	
Absolute Maximum Ratings	Commercial	108, 109
PIC16C54/55/56/5767	Industrial	108, 109
PIC16C54A103	DECF	54
PIC16C54C/CR54C/C55A/C56A/CR56A/C57C/CR57C/	DECFSZ	54
C58B/CR58B131	Development Support	61
PIC16C54C/CR54C/C55A/C56A/CR56A/C57C/CR57C/	Device Characterization	
C58B/CR58B-40	PIC16C54/55/56/57/CR54A	91
PIC16CR54A	PIC16C54A	
ADDWF	PIC16C54C/C55A/C56A/C57C/C58B-40	
	Device Reset Timer (DRT)	
ALU9	Device Varieties	
ANDLW	Digit Carry (DC) bit	
ANDWF51	DRT	
Applications5	DIX1	20
Architectural Overview9	E	
Assembler		
MPASM Assembler61	Electrical Specifications	07
В	PIC16C54/55/56/57	
В	PIC16C54A	
Block Diagram	PIC16C54C/CR54C/C55A/C56A/CR56A/C57C/	
On-Chip Reset Circuit20	C58B/CR58B	
PIC16C5X Series10	PIC16C54C/CR54C/C55A/C56A/CR56A/C57C/	
Timer037	C58B/CR58B-40	
TMR0/WDT Prescaler41	PIC16CR54A	79
Watchdog Timer46	Errata	3
Brown-Out Protection Circuit	External Power-On Reset Circuit	21
BSF	_	
BTFSC	F	
BTFSS	Family of Devices	
511 00	PIC16C5X	6
C	FSR Register	33
CALL31, 53	Value on reset	
·	14.45	
Carry (C) bit	G	
Clocking Scheme	General Purpose Registers	
CLRF53	Value on reset	20
CLRW	GOTO	
CLRWDT53	GO10	51, 55
CMOS Technology1	Н	
Code Protection43, 47		
COMF54	High-Performance RISC CPU	1
Compatibility182	I	
Configuration Bits44	•	
_	I/O Interfacing	
D	I/O Ports	
Data Memory Organization	I/O Programming Considerations	36
DC Characteristics	ICEPIC In-Circuit Emulator	62
PIC16C54/55/56/57	ID Locations	43, 47
Commercial	INCF	55
Extended	INCFSZ	55
Industrial	INDF Register	33
PIC16C54A	Value on reset	20
Commercial104, 109	Indirect Data Addressing	
•	Instruction Cycle	
Extended	Instruction Flow/Pipelining	
·	Instruction Set Summary	
PIC16C54C/C55A/C56A/C57C/C58B-40	IORLW	
Commercial	IORUWIORWF	
PIC16C54C/CR54C/C55A/C56A/CR56A/C57C/CR57C/	IOIXWF	56
C58B/CR58B	K	
Commercial134, 138		٠.
Extended137, 138	KeeLoq Evaluation and Programming Tools	64
Industrial134, 138	L	
PIC16CR54A		
Commercial 80, 83	Loading of PC	31

ON-LINE SUPPORT

Microchip provides on-line support on the Microchip World Wide Web (WWW) site.

The web site is used by Microchip as a means to make files and information easily available to customers. To view the site, the user must have access to the Internet and a web browser, such as Netscape or Microsoft Explorer. Files are also available for FTP download from our FTP site.

Connecting to the Microchip Internet Web Site

The Microchip web site is available by using your favorite Internet browser to attach to:

www.microchip.com

The file transfer site is available by using an FTP service to connect to:

ftp://ftp.microchip.com

The web site and file transfer site provide a variety of services. Users may download files for the latest Development Tools, Data Sheets, Application Notes, User's Guides, Articles and Sample Programs. A variety of Microchip specific business information is also available, including listings of Microchip sales offices, distributors and factory representatives. Other data available for consideration is:

- Latest Microchip Press Releases
- Technical Support Section with Frequently Asked Questions
- · Design Tips
- Device Errata
- · Job Postings
- Microchip Consultant Program Member Listing
- Links to other useful web sites related to Microchip Products
- Conferences for products, Development Systems, technical information and more
- · Listing of seminars and events